A 3DIC system to aid in the acceleration of systems that employ multiple instances of artificial neural networks

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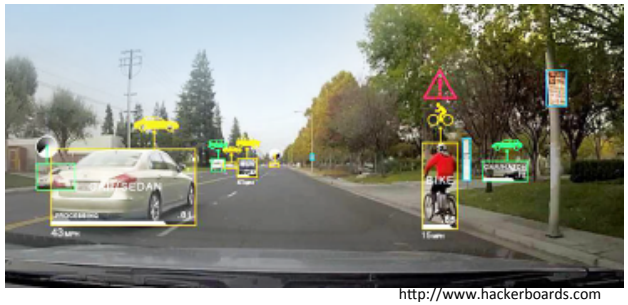
Introduction

- Recently Artificial Neural networks (NN) have demonstrated superior performance in classification and function approximation

Deep Neural Networks (DNN) have been very successful in image processing applications [Kri12]

– it is anticipated that DNNs will be employed more and more in self-driving cars

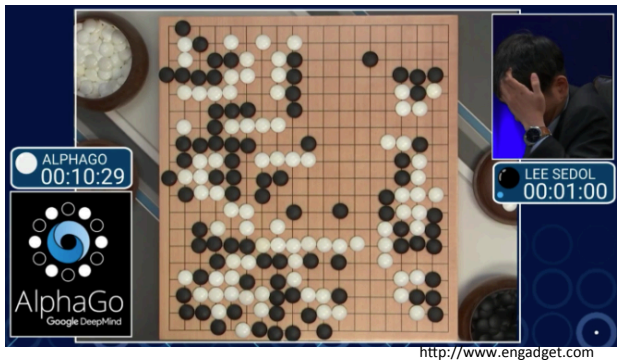


http://www.hackerboards.com

http://www.BGR.com

Reinforcement learning is gaining popularity

– alphaGo employed reinforcement learning with deep neural networks [Mad14]



http://www.engadget.com

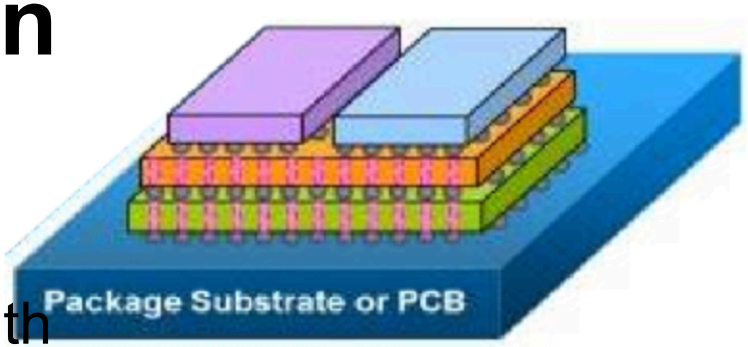
Introduction

- Many applications will and do require multiple NN engines running at or near real-time
  - car or drone scanning in many directions during navigation
  - cloud server processing multiple images when searching
  - reinforcement learning requires multiple state-action value calculations during optimal policy searches
  - text recognition system processing multiple pages of text

Problem

- Many applications will/do have power, space and weight limitations
  - drone
  - server rack has building cooling limitations
- Useful Neural Networks are big
  - lots of memory and computations → bandwidth
  - local SRAM consumes too much silicon
- To achieve near or at real-time processing, current solutions require high power and high real-estate
  - GPU solutions have large real-estate and power requirements (~100-200W)
  - ASIC's target smaller network sizes and/or specific NN's
  - Both have memory bandwidth limitations

Solution



http://www.semiwiki.com

- 3DIC Architecture
  - reduces energy and area
  - increase connectivity and bandwidth
- 3D-DRAM
  - provide high bandwidth and large storage
  - minimize dependency on SRAM
- Data Structures
  - data structures to ensure neural network data can be accessed efficiency
  - maintain constant access to DRAM to avoid dependency on local SRAM
- Specialized processing layers
  - provide special functions to aid in acceleration of target neural networks

Contribution

- Research uniquely organized 3DIC DRAM
  - research bank and page organization for a family of neural networks
  - maintain efficient read and writing
- Research and propose Data Structures to exploit DRAM capacity
  - in conjunction with DRAM organization
  - data structures organized to allow efficient streaming of data directly to processing layers
- Propose 3D architecture to take advantage of DRAM bandwidth
  - memory management to manage configuration and algorithm operations and coalesced accesses
  - processing layer contains special functions for a family of NN's

Outline

1. What are artificial Neural networks
2. **Target Neural networks**
3. State-of-the-art
4. Proposed Architecture
   - Problem
   - Solution
5. Preliminary Work
   - 3DIC DRAM and data structures
   - 3D Stack Bus
   - Processing Layer
6. Research Plan
7. Summary

Target ANN Type's

- This work will focus on the following ANNs :
  - Deep Neural Network Classifiers
  - ANN in Reinforcement Learning
  - Cogent Confabulation
  - Brain-state-in-a-Box
- Our research will involve analyzing memory access and processing requirements

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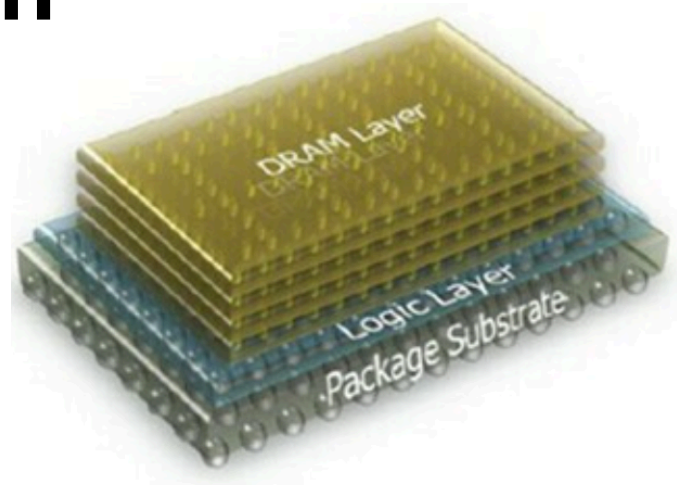
Problem

- System solution requiring multiple NN's
  - Consider a system that requires ~8 DNNs[Boj16]
  - ~16Gb of memory
  - ~100W per GPU suggests >800W total power
- Real-Time
  - Image needs to be processed ~16mS (60 frames/sec)
  - Allowing ~10mS for classification requires ~1700GFLOPS[1]
  - Required Memory bandwidth ~54Tbps
- Current 3D-DRAM memory technology bandwidth
  - **HMC – SERDES~2Tbps**
  - **HBM – wide DDR ~2Tbps**
  - **Tezzaron DiRAM4 – wide DDR – 4Tbps**

Solution

- Utilize 3DIC technology



http://www.electroiq.com/

- Architecture includes:
  - Custom organized 3D-DRAM specification
  - Data Structures specific to each ANN
  - Management Layer for configuration and control
  - Processing layer(s) targeted toward a family of ANNs
    - array of processing engines (PE) with special streaming functions
    - PE will include small CPU to process non hot-spot functions and provide some generality

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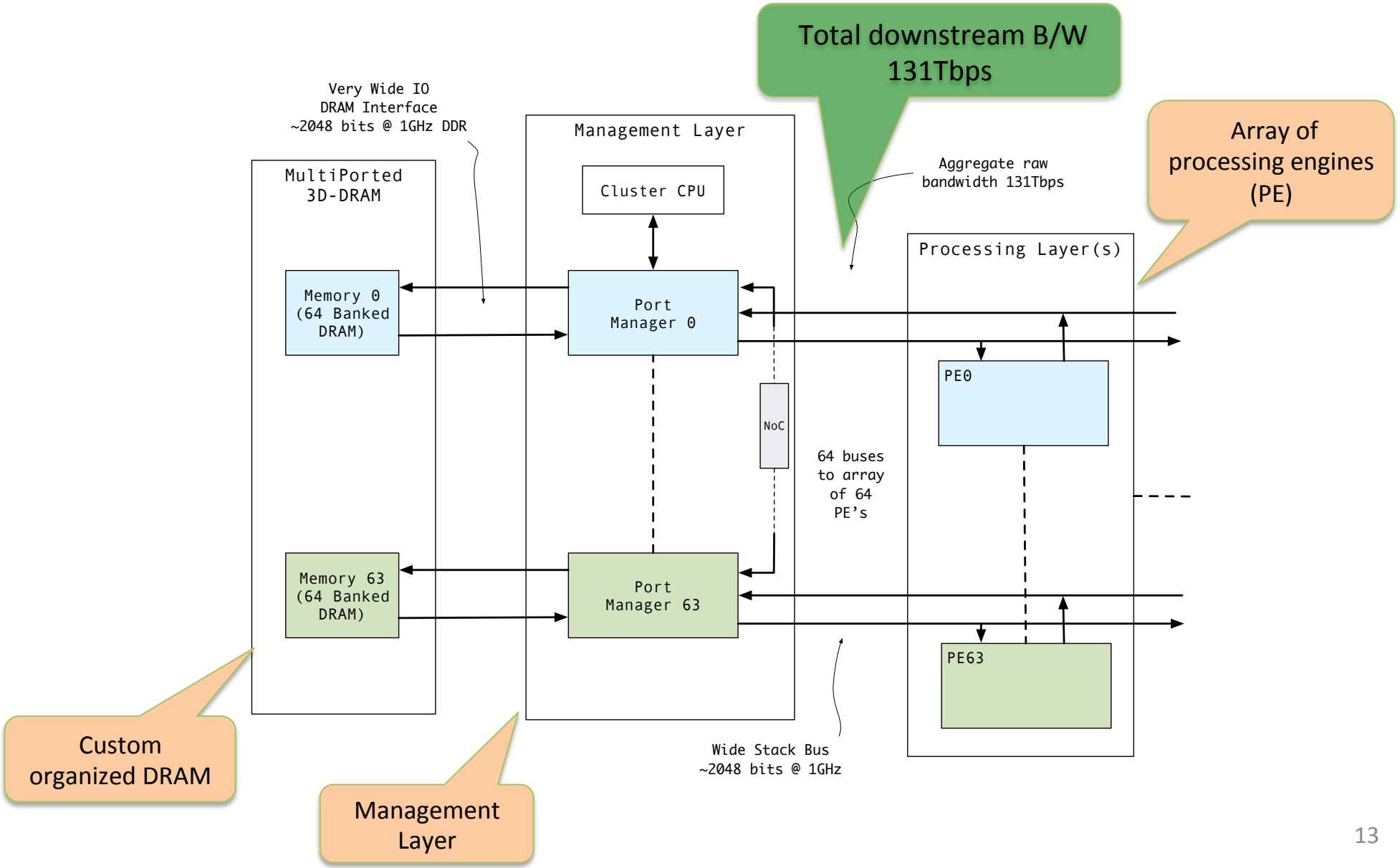
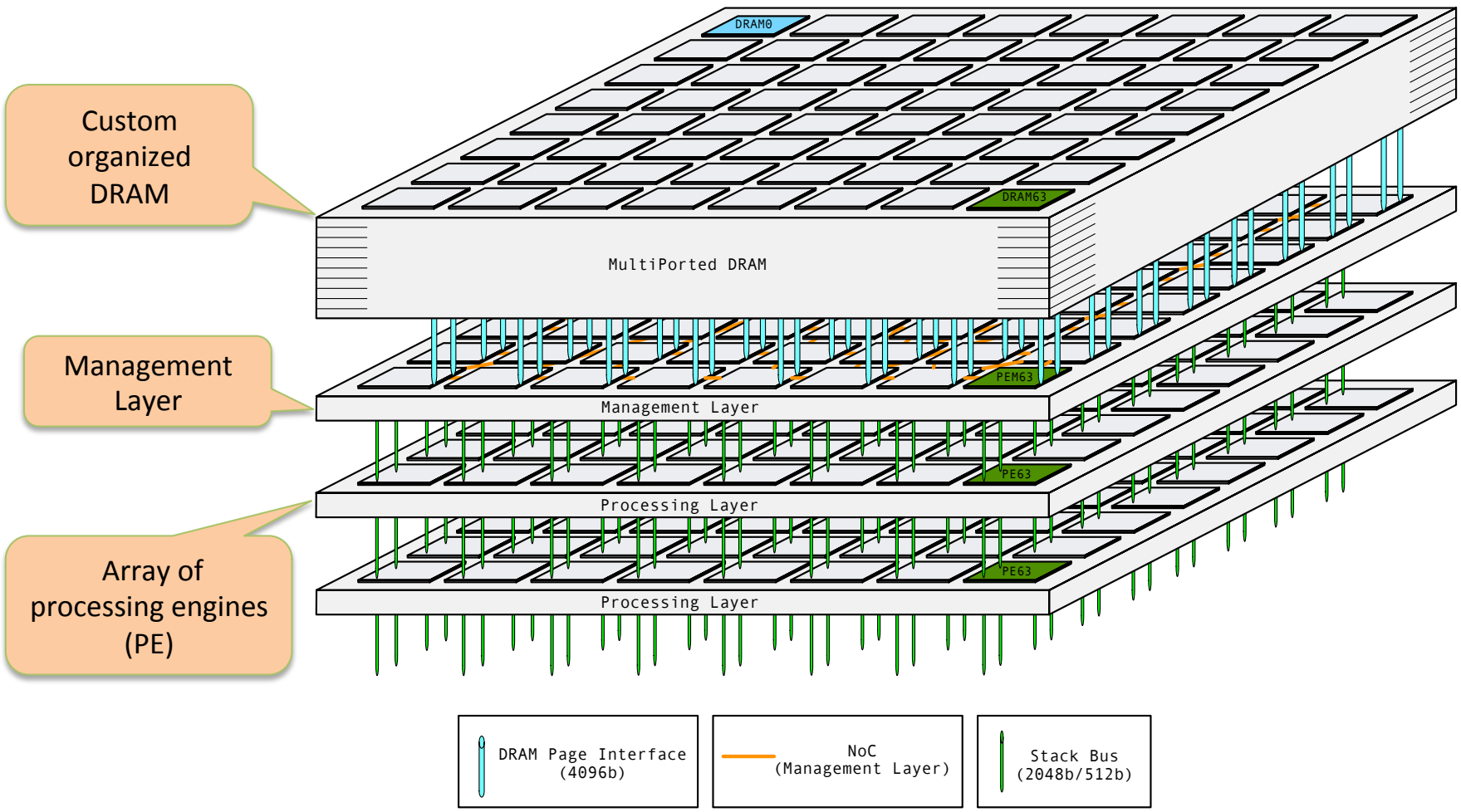
Solution Block Diagram

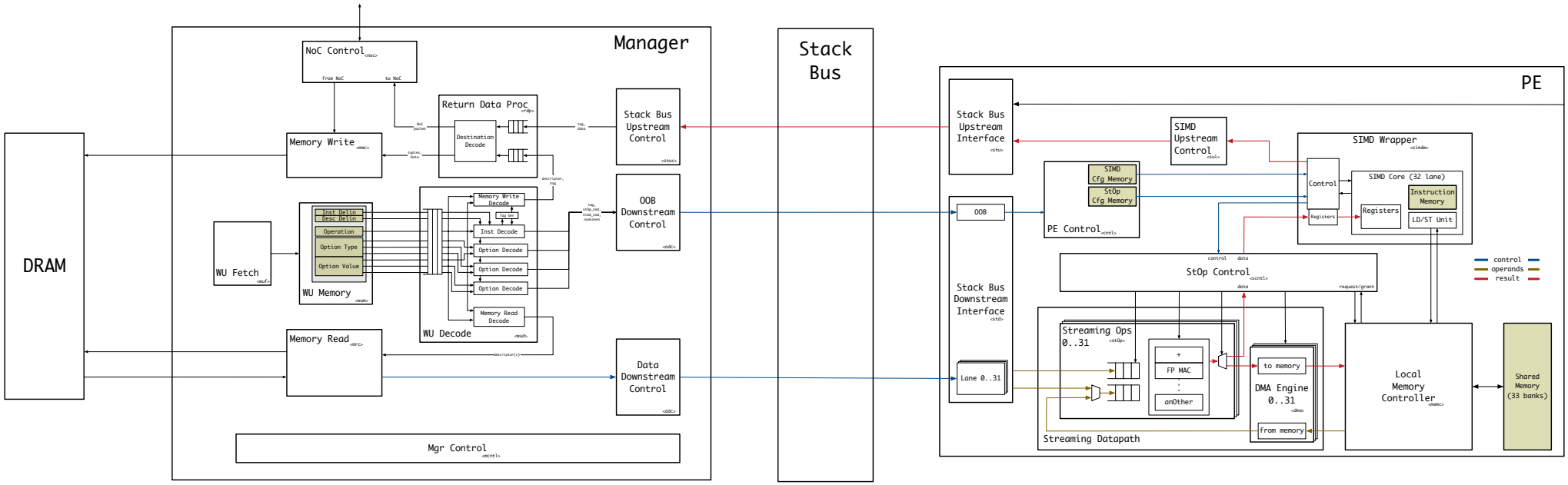


3D Configuration



System Column

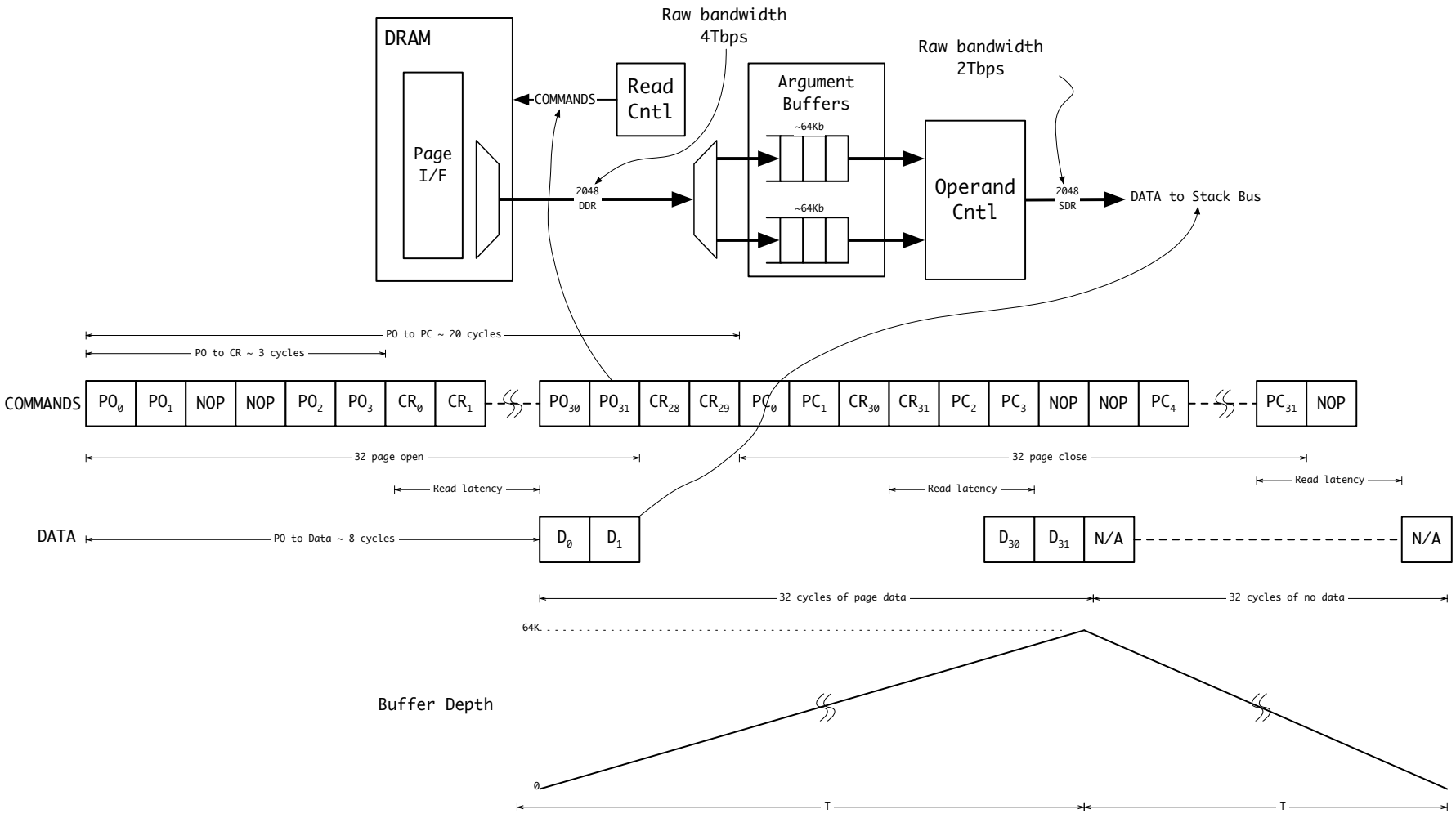
- A processing column includes:
  - DRAM port
  - Manager
    - process set of instructions which implement a NN
    - manage configuration of PE and communication of results
  - PE
    - take data from Manager/ DRAM via stack bus
    - operate on data at line rate to generate neuron activations
    - silicon focused on processing required not storage



DRAM Ports, Bus Widths and PE Array Size

- Determined how many PE's required to support bandwidth needs
  - based on available GOPS, current DRAM technology and reasonable operating frequency
- Size data width to provide enough operands to each execution lanes (EL)
- Estimated 64-port memory each supporting a processing engine with 32 execution lanes
- Review DRAM operations to stream data for power dissipation

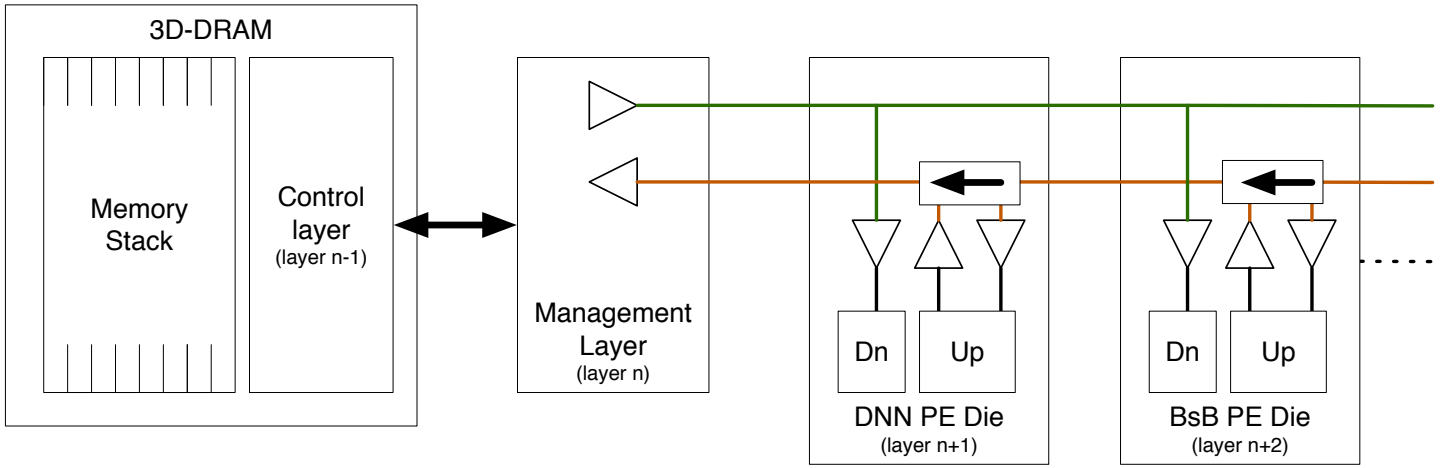
Example DRAM Access Sequence



3D Stack Bus

Stack Bus

- Each processing column has a downstream and upstream stack bus
  - Downstream 2048[1] bit running at 1GHz providing131Tbps raw system bandwidth
  - Upstream bus 512[2] bits running at 1GHz
    - result bandwidth ~1/100th of operand bandwidth



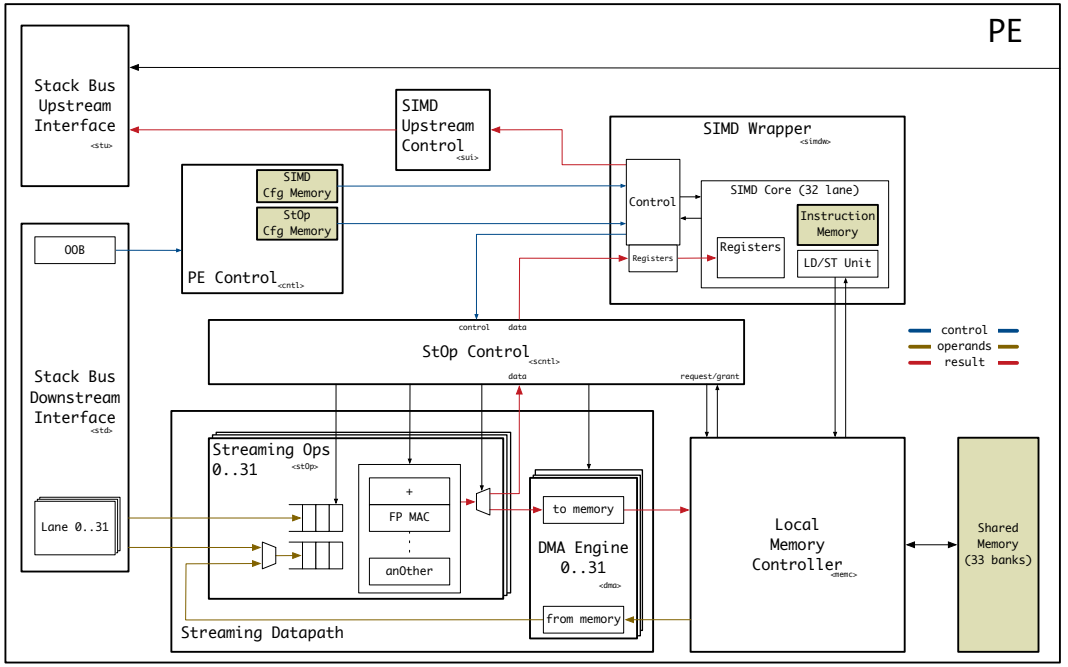
Stack Bus

- Downstrean and upstream buses
- Buses carry control packets and data packets
  - packets will be multiple clock cycles
- Control packets used to configure PE
  - special function and SIMD operations
  - result information
- Data Packets will carry arguments for special functions
  - data to will be multiple cycles of two 32-bit words

Processing Layer

Special Functions in PE

- Special Functions are designed to operate on data from the Stack bus
  - operate at line rate from downstream bus
  - perform computations directly as data is read from memory
  - avoid need for large local SRAM in PE
  - result is passed to “small” local memory or registers for later processing by SIMD
  - result sent to upstream bus



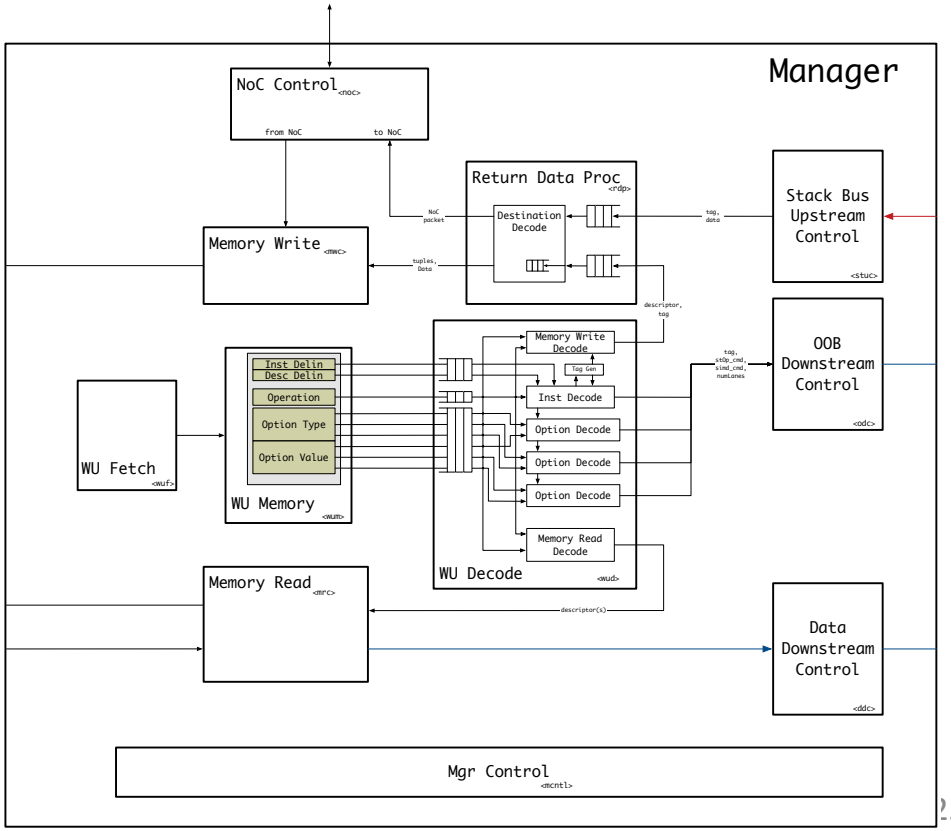
PE Status

- FMA streaming operation functionality coded
- SIMD has yet to be integrated
  - a wrapper around SIMD allows system to operate normally except SIMD doesn't process neuron outputs
- SV environment generates PE configuration packets and streams neuron weights and inputs to PE
  - Result verified by examining result packet on upstream stack bus

Management Layer

Manager

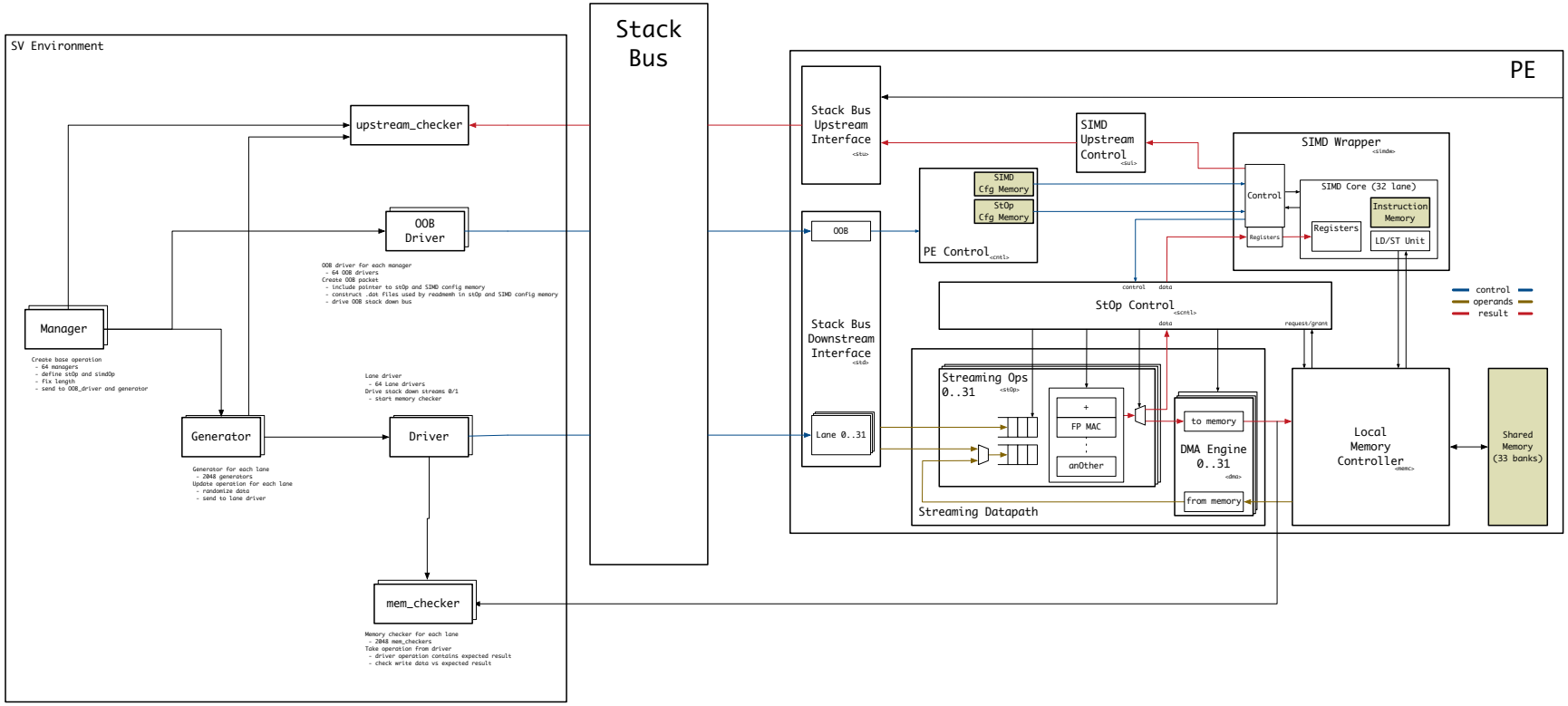
- Ensure data can be streamed efficiently from DRAM
- Operates on a custom instruction set
  - instructions describe all that is necessary to process a group of neurons
  - avoid need for large local SRAM in PE
- System requires data duplication
  - NoC designed to multicast neuron activations to other managers



Manager Status

- Basic functionality except Memory read and Write are coded
- Manager instructions generated from python script
  - instructions include a group of descriptors that specify:
    - PE operation
    - source of weights and inputs
    - where to write results
  - python script generates readmem files
- SV
  - environment still generates neuron weights and inputs to PE
  - Manager code generates configuration packets from instructions
  - Manager code takes results from upstream stack bus and constructs NoC packets for writes to local memory and other manager memory

Verification Block diagram



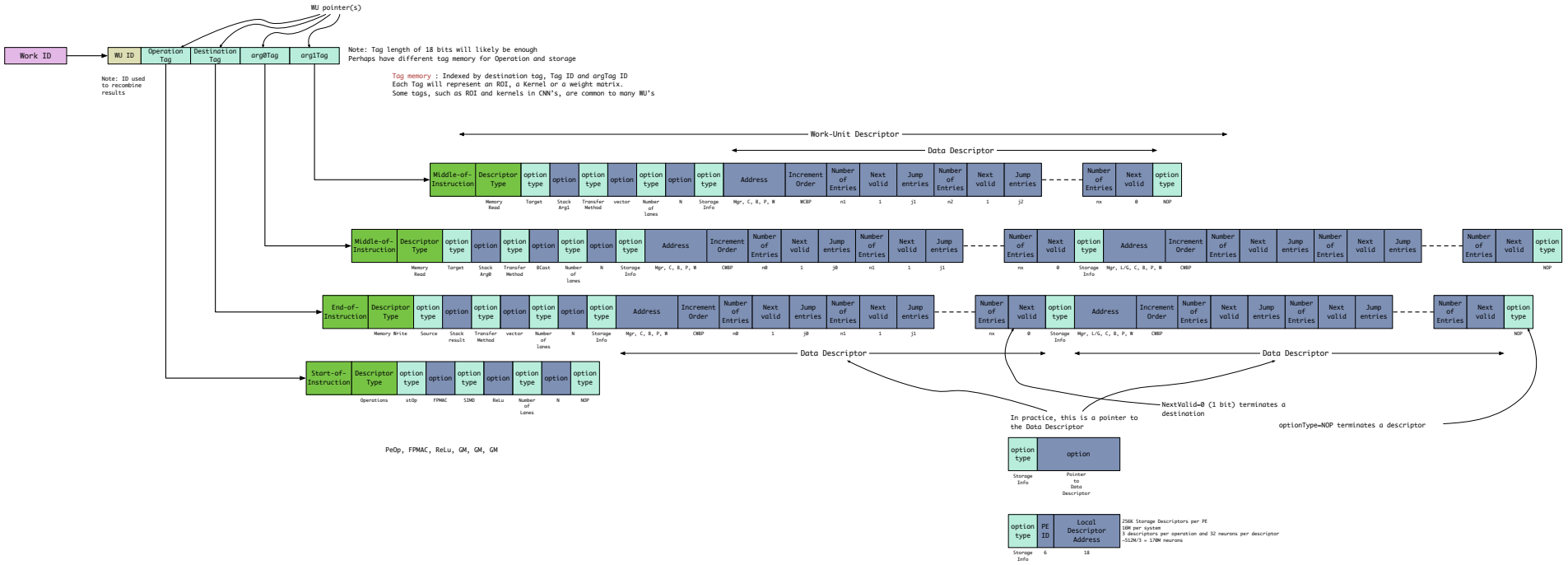
WU/Instruction Format

- Instruction must describe operations for processing a group of neurons
- Describe operations performed for a group of neurons
  - convolution on weights and input
  - Relu or Sigmoid to generate activation
  - how to read weights
  - how to read inputs
  - how to save neuron activations
- Instruction decoder generates:
  - OOB configuration packets to PE to configure SIMD and PIM stOp
  - Information to return Data processor describing where result should be sent
    - RDP sends result data along with write descriptor pointers to local manager or other managers over NoC
  - Read descriptors pointers to memory read modules to send operation arguments down stack bus to PE

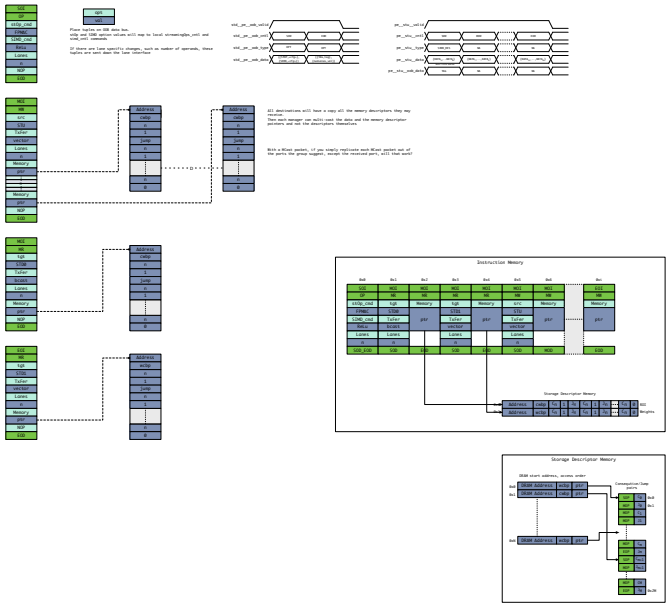
WU/Instruction Format

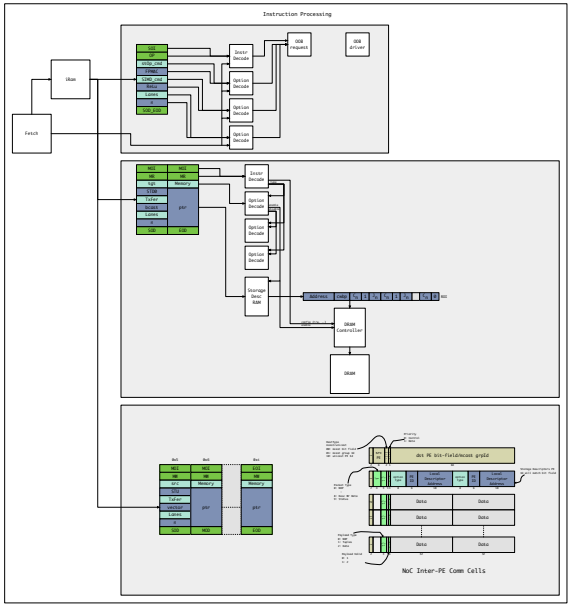
- Instructions formed from a set of descriptors
- Descriptors for:
  - Operations
  - memory Read
  - memory Write
  - access method
- Operation descriptor
  - defines SIMD and stOp operations
  - SIMD and StOp operation stored in PE instruction memory
  - descriptors point to instructions in PE IM
- Memory read and write Descriptor
  - sets start address
  - describes how address is accessed
    - bank/page/word increment order
    - how data is transferred to stack bus and on to PE
  - memory descriptor points to an access descriptor that is stored in manager memory
  - expect commonality amongst access methods so many descriptors may point to same access descriptor
- Access descriptor
  - not used in the actual instruction
  - expect some commonality between memory read and writes so avoid replicating access descriptor

WU/Instruction Format

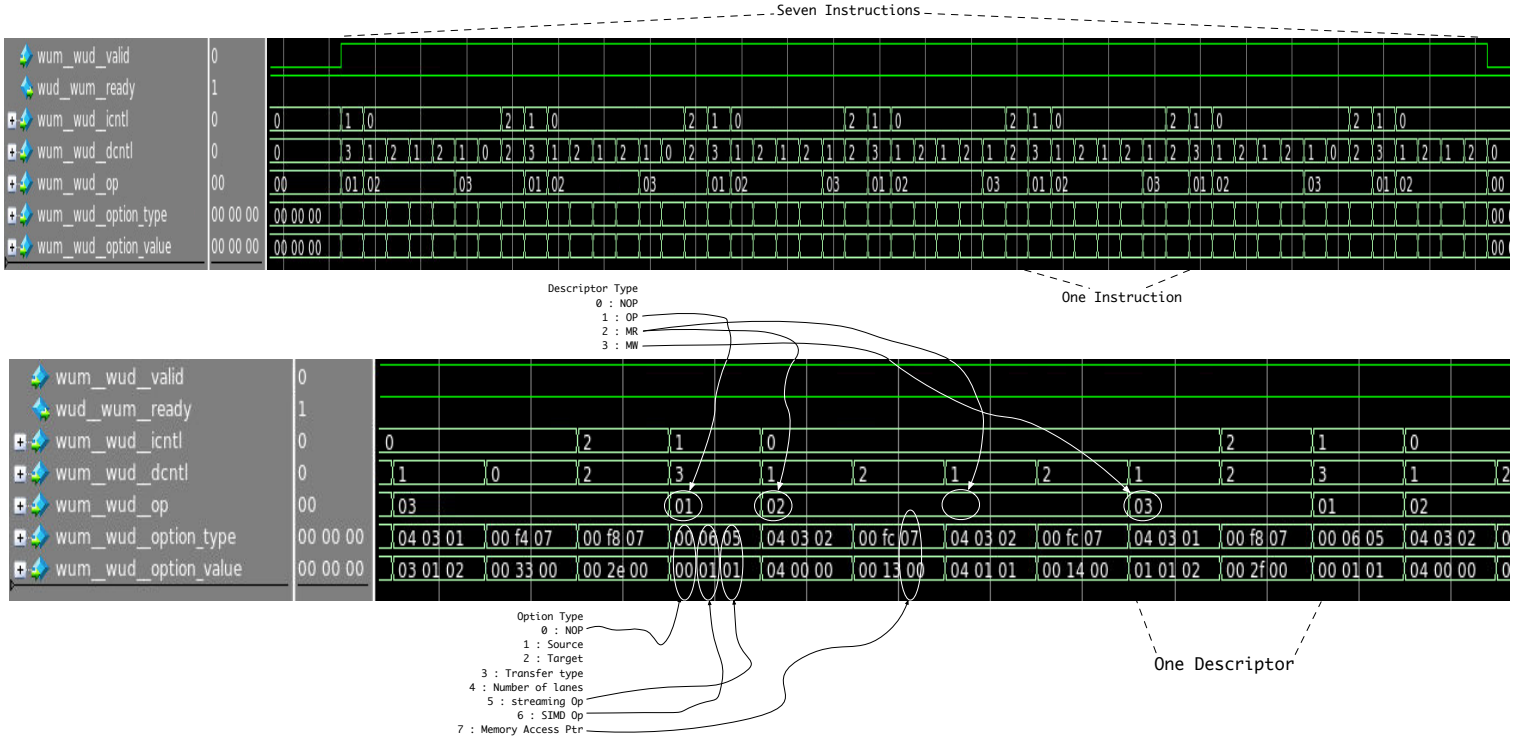


WU/Instruction Processing





Instruction Communication



NoC Signaling